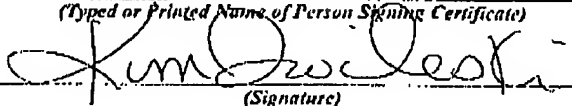


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CERTIFICATE OF TRANSMISSION BY FACSIMILE (37 CFR 1.8)			Docket No. END920020007US1	
Applicant(s): Choi et al.				
Serial No. 10/078,020	Filing Date 2/15/2002	Examiner Zimmerman, John J.	Group Art Unit 1775	
Invention: LEAD-FREE TIN-SILVER-COPPER ALLOY SOLDER COMPOSITION			RECEIVED CENTRAL FAX CENTER DEC 24 2003	
<p>I hereby certify that this <u>Amendment (30 pages)</u> (Identify type of correspondence)</p> <p>is being facsimile transmitted to the United States Patent and Trademark Office (Fax. No. <u>703-872-9306</u>)</p> <p>on <u>12/24/2003</u> (Date)</p> <p><u>Kim Dwileski</u> (Typed or Printed Name of Person Signing Certificate)</p> <p><u></u> (Signature)</p> <p>Note: Each paper must have its own certificate of mailing.</p>				

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Applicant: Choi *et al.*

Examiner: Zimmerman, John J.

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Serial No.: 10/078,020

Art Unit: 1775

Filed: 2/15/2002

For: **LEAD-FREE TIN-SILVER-COPPER ALLOY SOLDER COMPOSITION**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action mailed October 2, 2003, please amend the above-identified application as follows:

10/078,020

1